



ISL6612ECBZ-T Information



For Reference Only

Part Number ISL6612ECBZ-T

Manufacturer Intersil

Category Integrated Circuits (ICs)

PMIC - Gate Drivers

DescriptionIC MOSFET DRVR SYNC BUCK 8EPSOIC**Package**8-SOIC (0.154", 3.90mm Width) Exposed Pad

For the pricing/inventory/lead time, please contact

us

Website: https://www.heisener.com E-mail: salesdept@heisener.com



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ISL6612ECBZ-T Specifications

Manufacturer Part Number Manufacturer Intersil Integrated Circuits (ICs) PMIC - Gate Drivers Package 8-SOIC (0.154", 3.90mm Width) Exposed Pad Series - Driven Configuration Half-Bridge Channel Type Synchronous Number of Drivers 2 Gate Type N-Channel MOSFET Voltage - Supply 10.8 V ~ 13.2 V Logic Voltage - VIL, VIH - Current - Peak Output (Source, Sink) Input Type Non-Inverting High Side Voltage - Max (Bootstrap) Rise / Fall Time (Typ) Operating Temperature Mounting Type Surface Mount Package / Case Supplier Device Package 8-SOIC (0.154", 3.90mm Width) Exposed Pad Report errors?			
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Series-Driven ConfigurationHalf-BridgeChannel TypeSynchronousNumber of Drivers2Gate TypeN-Channel MOSFETVoltage - Supply10.8 V ~ 13.2 VLogic Voltage - VIL, VIH-Current - Peak Output (Source, Sink)1.25A, 2AInput TypeNon-InvertingHigh Side Voltage - Max (Bootstrap)36VRise / Fall Time (Typ)26ns, 18nsOperating Temperature0°C ~ 125°C (TJ)Mounting TypeSurface MountPackage / Case8-SOIC (0.154", 3.90mm Width) Exposed PadSupplier Device Package8-SOIC-EP		PMIC - Gate Drivers	
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Gate TypeN-Channel MOSFETVoltage - Supply10.8 V ~ 13.2 VLogic Voltage - VIL, VIH-Current - Peak Output (Source, Sink)1.25A, 2AInput TypeNon-InvertingHigh Side Voltage - Max (Bootstrap)36VRise / Fall Time (Typ)26ns, 18nsOperating Temperature0°C ~ 125°C (TJ)Mounting TypeSurface MountPackage / Case8-SOIC (0.154", 3.90mm Width) Exposed PadSupplier Device Package8-SOIC-EP	Channel Type	Synchronous	
Voltage - Supply Logic Voltage - VIL, VIH - Current - Peak Output (Source, Sink) Input Type Non-Inverting High Side Voltage - Max (Bootstrap) Rise / Fall Time (Typ) Operating Temperature O°C ~ 125°C (TJ) Mounting Type Surface Mount Package / Case 8-SOIC (0.154", 3.90mm Width) Exposed Pad Supplier Device Package	Number of Drivers	2	
Logic Voltage - VIL, VIH Current - Peak Output (Source, Sink) Input Type Non-Inverting High Side Voltage - Max (Bootstrap) Rise / Fall Time (Typ) Operating Temperature O°C ~ 125°C (TJ) Mounting Type Surface Mount Package / Case 8-SOIC (0.154", 3.90mm Width) Exposed Pad Supplier Device Package	Gate Type	N-Channel MOSFET	
Current - Peak Output (Source, Sink) Input Type Non-Inverting High Side Voltage - Max (Bootstrap) Rise / Fall Time (Typ) Operating Temperature O°C ~ 125°C (TJ) Mounting Type Surface Mount Package / Case 8-SOIC (0.154", 3.90mm Width) Exposed Pad Supplier Device Package	Voltage - Supply	10.8 V ~ 13.2 V	
Input Type Non-Inverting High Side Voltage - Max (Bootstrap) Rise / Fall Time (Typ) 26ns, 18ns Operating Temperature 0°C ~ 125°C (TJ) Mounting Type Surface Mount Package / Case 8-SOIC (0.154", 3.90mm Width) Exposed Pad Supplier Device Package 8-SOIC-EP	Logic Voltage - VIL, VIH	-	
High Side Voltage - Max (Bootstrap) Rise / Fall Time (Typ) 26ns, 18ns Operating Temperature 0°C ~ 125°C (TJ) Mounting Type Surface Mount Package / Case 8-SOIC (0.154", 3.90mm Width) Exposed Pad Supplier Device Package	Current - Peak Output (Source, Sink)	1.25A, 2A	
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Operating Temperature0°C ~ 125°C (TJ)Mounting TypeSurface MountPackage / Case8-SOIC (0.154", 3.90mm Width) Exposed PadSupplier Device Package8-SOIC-EP	High Side Voltage - Max (Bootstrap)	36V	
Mounting Type Surface Mount Package / Case 8-SOIC (0.154", 3.90mm Width) Exposed Pad Supplier Device Package 8-SOIC-EP	Rise / Fall Time (Typ)	26ns, 18ns	
Package / Case 8-SOIC (0.154", 3.90mm Width) Exposed Pad Supplier Device Package 8-SOIC-EP	Operating Temperature	0°C ~ 125°C (TJ)	
Supplier Device Package 8-SOIC-EP	Mounting Type	Surface Mount	
	Package / Case	8-SOIC (0.154", 3.90mm Width) Exposed Pad	
Report errors?	Supplier Device Package	8-SOIC-EP	
X X			Report errors?

ISL6612ECBZ-T Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

ISL6612ECBZ-T Payment Methods



















ISL6612ECBZ-T Shipping Methods













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